

TFW

843.40341CX1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Y. SAITOH et al
Serial No.: 10/764,539
Filed: January 27, 2004
For: SEMICONDUCTOR WAFER, SEMICONDUCTOR
CHIP, AND MANUFACTURING METHOD OF
SEMICONDUCTOR CHIP
Group: 2811
Examiner: T. NGUYEN

PRELIMINARY AMENDMENT

MS: PATENT APPLICATIONS

Commissioner for Patents
POB 1450
Alexandria, VA 22313-1450

April 30, 2004

Sir:

Please amend the above-identified application as listed below and as set forth on the following pages:

Amendment to the Specification.

Amendments to the Claims.

Remarks are included following the Amendments.